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### FDB3860 N-Channel PowerTrench<sup>®</sup> MOSFET 100 V, 30 A, 37 mΩ

#### Features

- Max  $r_{DS(on)}$  = 37 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 5.9 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- 100% UIL tested
- RoHS Compliant

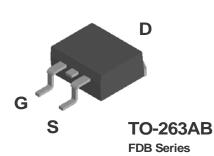


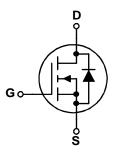
#### **General Description**

This N-Channel MOSFET is rugged gate version of Fairchild Semiconductor's advanced Power Trench<sup>®</sup> process. This part is tailored for low  $r_{DS(on)}$  and low Qg figure of merit, with avalanche ruggedness for a wide range of switching applications.

#### Applications

- DC-AC Conversion
- Synchronous Rectifier





#### MOSFET Maximum Ratings T<sub>C</sub> = 25 °C unless otherwise noted

Symbol	Parameter			Ratings	Units	
V <sub>DS</sub>	Drain to Source Voltage			100	V	
V <sub>GS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current -Continuous (Silicon limited)	T <sub>C</sub> = 25 °C		30		
	-Continuous	T <sub>A</sub> = 25 °C	(Note 1a)	6.4	Α	
	-Pulsed			60	_	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	96	mJ	
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C		71		
	Power Dissipation	T <sub>A</sub> = 25 °C	(Note 1a)	3.1		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C	

#### **Thermal Characteristics**

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case		1.75	°C/W
$R_{\theta,JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	40	C/W

#### Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDB3860	FDB3860	TO-263AB	330 mm	24 mm	800 units

March 2009

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Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu\text{A}$ , referenced to 25 °C		104		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μA
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
On Chara	acteristics					
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	2.5	3.8	4.5	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-11		mV/°C
-	Chatia Drain ta Cauran On Danistanan	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 5.9 A		31	37	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS}$ = 10 V, I <sub>D</sub> = 5.9 A, T <sub>J</sub> = 125 °C		56	67	mΩ
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 5.9 \text{ A}$		18		S
Dynamic	Characteristics					
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V,		1310	1740	pF
C <sub>oss</sub>	Output Capacitance			100	130	pF
C <sub>rss</sub>	Reverse Transfer Capacitance			40	65	pF
R <sub>g</sub>	Gate Resistance			1.7		Ω
Switching	g Characteristics					
t <sub>d(on)</sub>	Turn-On Delay Time			12	22	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 5.9 A,		6	12	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		17	31	ns
t <sub>f</sub>	Fall Time			3	10	ns
Q <sub>q</sub>	Total Gate Charge at 10 V			21	30	nC
Q <sub>gs</sub>	Gate to Source Charge	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 5.9 A		6.9		nC
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			5.4		nC
	urce Diode Characteristics					
		$V_{GS} = 0 V, I_S = 2.0 A$ (Note 2)		0.7	1.2	
V <sub>SD</sub>	Source to Drain Diode Forward Voltade			0.8	1.3	V
				1		

Q<sub>rr</sub> Notes:

t<sub>rr</sub>

1:  $R_{\theta,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins.  $R_{\theta,JC}$  is guaranteed by design while  $R_{\theta,JA}$  is determined by the user's board design.

 $I_F = 5.9 \text{ A}, \, di/dt = 100 \text{ A}/\mu \text{s}$ 

a. 40 °C/W when mounted on a 1  $\mbox{in}^2$  pad of 2 oz copper

b. 62.5 °C/W when mounted on a minimum pad.

2: Pulse Test: Pulse Width < 300  $\mu s,$  Duty cycle < 2.0%. 3: Starting T\_J = 25 °C, L = 3 mH, I\_{AS} = 8 A, V\_{DD} = 100 V, V\_{GS} = 10 V.

Reverse Recovery Time

Reverse Recovery Charge

2

35

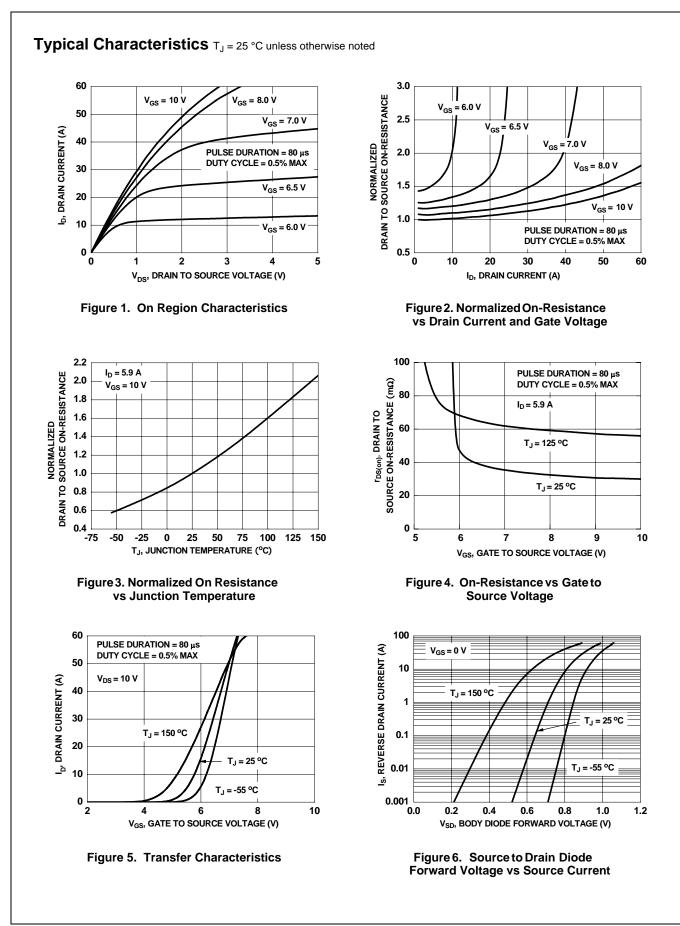
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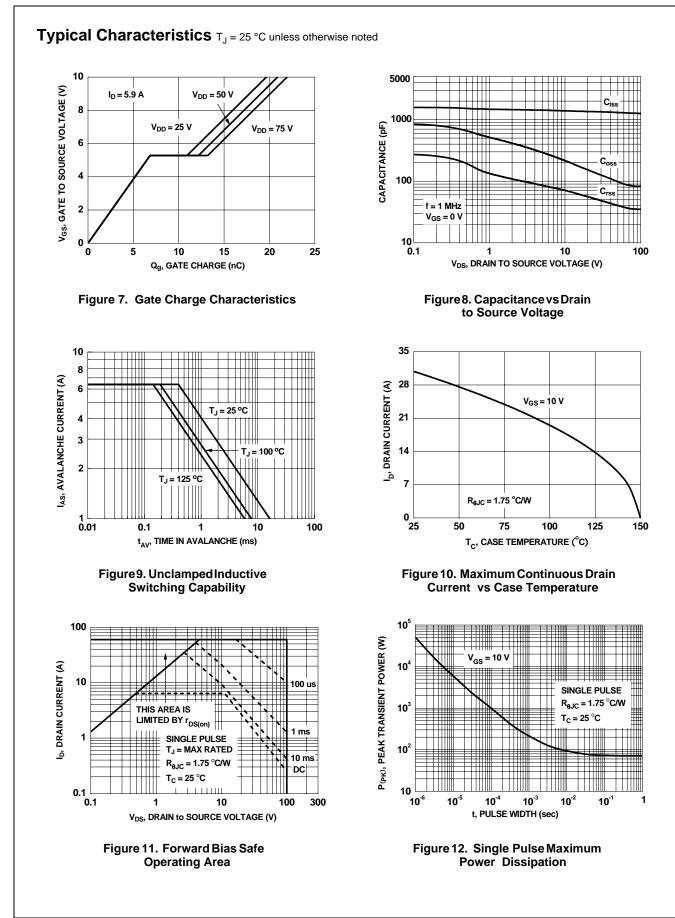
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ns

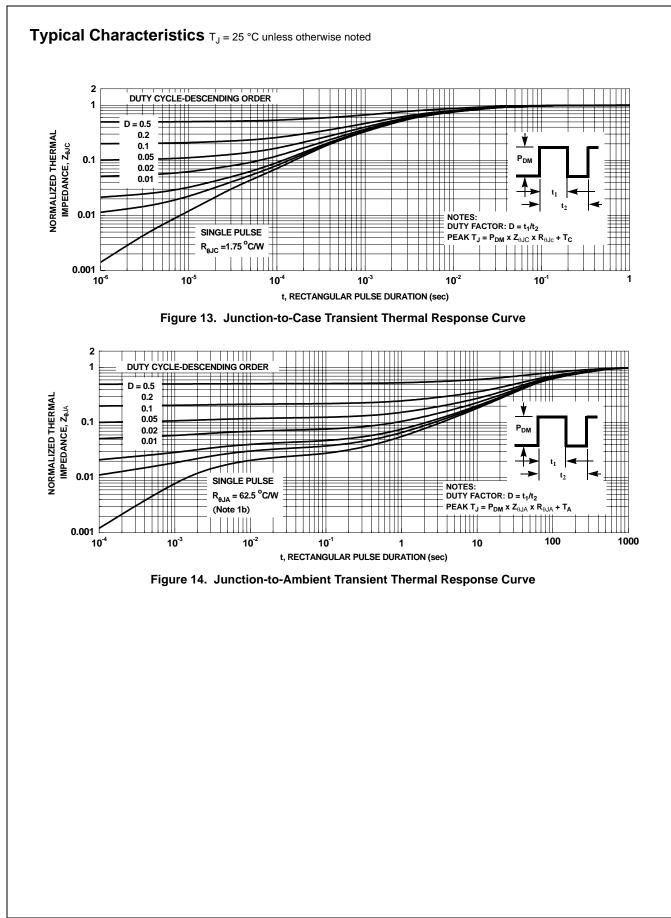
nC



FDB3860 N-Channel PowerTrench<sup>®</sup> MOSFET



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